

We are pleased to announce that the 2nd DVCon Taiwan (DVCon Taiwan 2024) will be held on September 10, 2024, at National Yang Ming Chiao Tung University (NYCU), Hsinchu, Taiwan. DVCon Taiwan is aimed to provide a platform to interact and exchange ideas and visions for advances in Design and Verification.

On behalf of the Steering Committee, we cordially invite you to join this exciting event as our sponsor. Your participation will be a great contribution to the success of this conference.

Please kindly reply to us before July 31, 2024 if you would like to sponsor. We sincerely hope you will be able to join us and contribute to the continued success of DVCon Taiwan 2024. If you have any inquiry, please do not hesitate to contact us at dvcon.tw@gmail.com

We look forward to your response and seeing you in Taiwan!

Steering Committee:

General Chair: Penny Yang – Synopsys

Vice Chair: Ying-Cherng Lan - Cadence

Exhibit Chair: Michael Chiang - Siemens EDA

Marketing Chair: Alan Su – eNeural

Marketing Co-Chair: Robert Chen – TESDA

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Program Co-Chair: Yung Jen Chen - Realtek

Program Co-Chair : SJ Wu – Andes Keynote Chair : Leo Chen – Nvidia Tutorial Chair : Prosper Chen – AMD Panel Chair : Jim Kung – MediaTek

Contest Chair: Philip Tsai - GUC



About DVCon Taiwan

- Date: September 10th, 2024 (Tuesday)
- Venue : Microelectronics and Information Research Center, NYCU, Hsinchu, Taiwan
- Organizer: Taiwan IC Design Society (TICD), Accellera System Initiative
- Co-Organizer: NYCU SoC Center (國立陽明交通大學晶片中心)
- DVCon Taiwan Website : https://dvcontaiwan.org/
- TICD Website: https://www.ticd.org.tw/

Inviting you to take advantage of the sponsorship opportunities for the event.

- Platinum Sponsor
 - o Cost: 200k NTD
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 - Your company logo on DVCon Taiwan Home Page as Platinum sponsor
 - Your company can get one exhibit booth
 - o 6 free delegate registrations
- Golden Sponsor
 - o Cost: 100k NTD
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 - Your company logo displayed in the venue as Golden sponsor
 - o Your company logo displayed on the conference home page as Golden sponsor
 - 4 free delegate registrations
- Silver Sponsor
 - Cost: 50k NTD
 - Your company logo on DVCon Taiwan Home Page as Silver Sponsor
 - Your company logo displayed in the venue as Silver sponsor
 - 2 free delegate registrations



September 10, 2024

Sponsored bank information

The funding of DVCon Taiwan is collected locally by Taiwan IC Design Society (TICD). The sponsorship for DVCon Taiwan will be invoiced through TICD.

Account Name: Taiwan IC Design Society

Name of Bank: Hua Nan Commercial Bank, Ltd. TAITA Branch

Account Number: 154-10-0000222-1

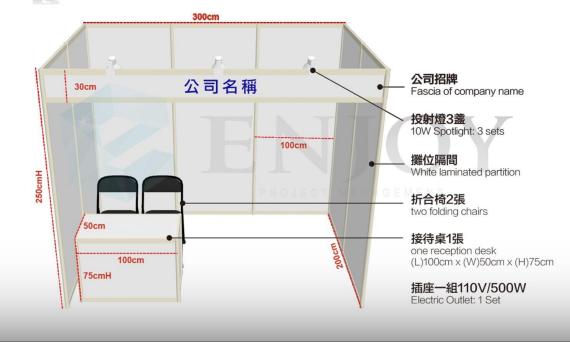
Swift Code: HNBKTWTP154

Address of Bank: No. 1, Sec 4, Roosevelt Rd., Taipei 106, Taiwan

Tel of Bank: +886-2-2363-1478

Exhibit Booth







September 10, 2024

贊助回函

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	黃金級	10 萬		Logo 筆		1萬		
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贊助總金額	NT\$							

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如有任何問題,歡迎與大會聯絡,謝謝!	
信箱:	复功丰位双丰

dvcon.tw@gmail.com

年	月	日